

APHB1608SGEC

1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode
- The High Efficiency Red source color devices are Made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode

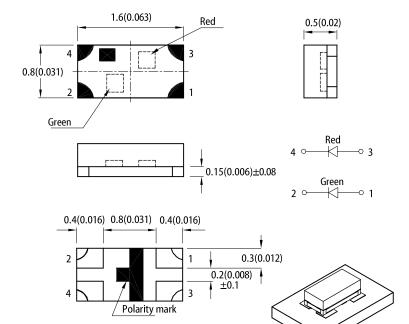
FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- Available in various color combination
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Tinned pads for improved solderability
- Halogen-free
- RoHS compliant

APPLICATIONS

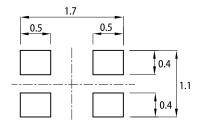
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 17. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.15(0.006") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	lv (mcd) @	20mA ^[2]	Viewing Angle [1]
r art Namber	(Material)	Lens Type	Min.	Тур.	201/2
APHB1608SGEC	Super Bright Green (GaP)	Water Clear	5	15	130°
			*5	*15	
	High Efficiency Red (GaAsP/GaP)		7	15	
			*5	*12	

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Farameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Super Bright Green High Efficiency Red	565 627	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Super Bright Green High Efficiency Red	568 617	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Super Bright Green High Efficiency Red	30 45	-	nm
Capacitance	С	Super Bright Green High Efficiency Red	15 15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Super Bright Green High Efficiency Red	2.2 2	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Super Bright Green High Efficiency Red	-	10 10	μА

Notes:

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Davanastan	Obl	Value		
Parameter	Symbol	Super Bright Green	High Efficiency Red	Unit
Power Dissipation	P_D	62.5	75	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	T _j	110	125	°C
Operating Temperature	T _{op}	-40 to +85		
Storage Temperature	T _{stg}	-40 to +85		°C
DC Forward Current	I _F	25	30	mA
Peak Forward Current	I _{FM} ^[1]	140	160	mA
Electrostatic Discharge Threshold (HBM)	-	8000	8000	V

Notes:

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



Notes:

1. The dominant wavelength (\(\lambda\)d) above is the setup value of the sorting machine. (Tolerance \(\lambda\)d: \(\pm\)1nm.)

2. Forward voltage: \(\pm\)2.1V.

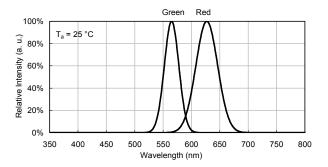
3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and \(\forall \) or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

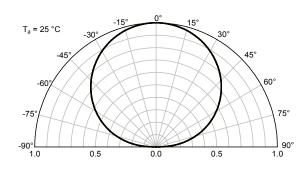


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

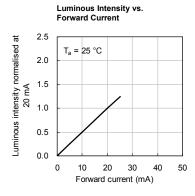


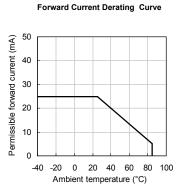
SPATIAL DISTRIBUTION

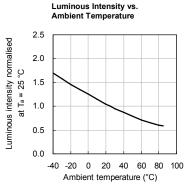


SUPER BRIGHT GREEN

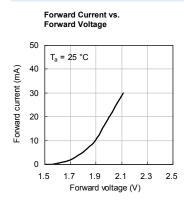
Forward Current vs. Forward Voltage T_a = 25 °C Forward current (mA) 40 20 2.7 1.9 2.1 2.3 2.5 1.7 Forward voltage (V)

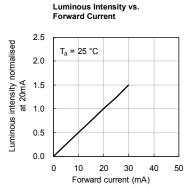


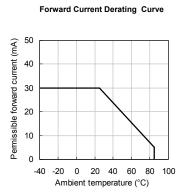


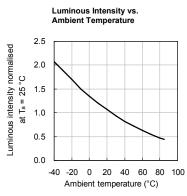


HIGH EFFICIENCY RED











REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 25°C 0 150 0 50 100 200 250 300 (sec) Time

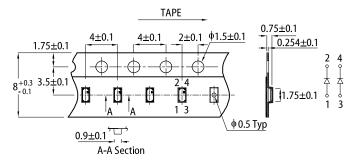
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

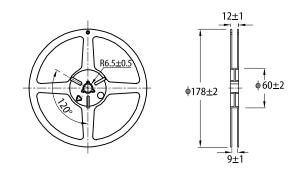
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

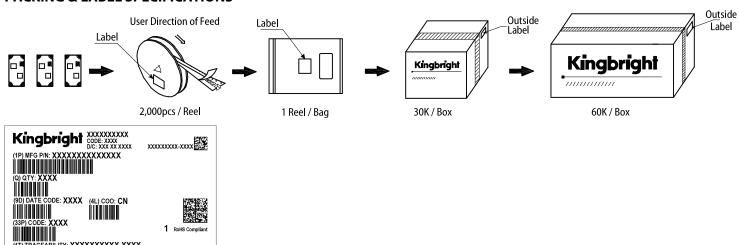
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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